

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5068318

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	CLUSTER LLC	12/20/2013
RECEIVING PARTY DATA		
Name:	UNWIRED PLANET, LLC	
Street Address:	P.O. BOX 250649	
City:	PLANO	
State/Country:	TEXAS	
Postal Code:	75025	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	16046009
CORRESPONDENCE DATA		
Fax Number:	(703)816-4100	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	703-816-4000	
Email:	PTOMAIL@nixonvan.com	
Correspondent Name:	NIXON & VANDERHYE P.C./OPTIS	
Address Line 1:	901 NORTH GLEBE ROAD, 11TH FLOOR	
Address Line 4:	ARLINGTON, VIRGINIA 22203	
ATTORNEY DOCKET NUMBER:	JRL-6490-143C	
NAME OF SUBMITTER:	JOHN R. LASTOVA	
SIGNATURE:	/John R. Lastova/	
DATE SIGNED:	07/26/2018	
Total Attachments: 9		
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EXECUTION VERSION

PATENT ASSIGNMENT AGREEMENT

This PATENT ASSIGNMENT AGREEMENT (“**Agreement**”) dated as of 20 December, 2013 (the “**Effective Date**”) by and between:

- (i) Cluster LLC, a Delaware limited liability company, with its registered office presently located at c/o National Corporate Research, Ltd., 615 South DuPont, Highway, Dover, Kent County, Delaware 19901 (“**Assignor**”); and
- (ii) Unwired Planet, LLC, a Nevada limited liability company, with its registered office presently located at 170 South Virginia Street, Suite 201, Reno, NV 89501, United States of America (“**Assignee**”).

WITNESSETH:

WHEREAS, Assignor and Assignee, among others, entered into a certain Master Sale Agreement, dated as of January 10, 2013 (the “**Master Sale Agreement**”);

WHEREAS, under the Master Sale Agreement Assignor agreed to transfer its rights in the Assigned Patents (as defined below) to Assignee; and

WHEREAS, Assignor now wishes to assign to Assignee its right, title and interest in and to the Assigned Patents.

NOW, THEREFORE, in consideration of the foregoing and the mutual promises and agreements contained in this Agreement, and for other good and valuable consideration the receipt and sufficiency of which are hereby acknowledged, the parties hereby agree as follows:

1. Assignment. Assignor hereby assigns, conveys and transfers to Assignee its right, title, and interest in and to all of the patents and patent applications set forth on Schedule A attached hereto (collectively, the “**Assigned Patents**”), in each case, subject to all existing encumbrances. Pursuant to the foregoing assignment, each of the Assigned Patents shall hereafter be for Assignee’s own use and enjoyment, and for the use and enjoyment of Assignee’s successors and assigns, as fully and entirely as the same would have been held and enjoyed by the applicable Assignor if this Agreement had not been made. The foregoing assignment includes, without limitation, the rights of Assignor, if any, to (A) register or apply in all countries and regions for patents, utility models, design registrations and like rights of exclusion and for inventors’ certificates for the Assigned Patents; (B) prosecute, maintain and defend the Assigned Patents before any public or private agency, office or registrar including by filing divisions, substitutes, extensions and all other applications and post issue proceedings included in the Assigned Patents; (C) claim priority based on the filing dates of any of the Assigned Patents under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, the Paris

Convention, and all other treaties of like purposes; and (D) sue and recover damages or other compensation for past, present or future infringements thereof, the right to sue and obtain equitable relief, including injunctive relief, in respect of such infringements, and the right to fully and entirely stand in the place of the applicable Assignor in all matters related to the Assigned Patents.

2. Authorization. Assignor also hereby expressly authorizes the respective patent office or governmental agency in each and every jurisdiction worldwide (including the Commissioner of Patents and Trademarks in the United States Patent and Trademark Office, and the corresponding entities or agencies in any applicable foreign countries or multinational authorities) (the “**Applicable IP Offices**”) to: (A) issue any and all patents or certificates of invention or equivalent which may be granted upon any of the Assigned Patents in the name of Assignee, as the assignee to the Assignor’s interest therein; and (B) record Assignee as the assignee of the Assigned Patents and to deliver to Assignee, and to Assignee’s attorneys, agents, successors or assigns, all official documents and communications as may be warranted by this Agreement.

3. Further Assurances. Each party hereby agrees to execute and deliver to the other party all necessary documents and take all necessary actions reasonably requested by such party from time to time to confirm or effect the assignments set forth in this Agreement, or otherwise to carry out the purposes of this Agreement, including, without limitation, by providing executed originals of short-form assignment agreements entered into by Assignor and Assignee on the Effective Date for filing or otherwise evidencing the assignments set forth in this Agreement with the Applicable IP Offices; provided, however, that nothing contained herein shall obligate Assignor to incur any cost or pay any expense in connection therewith.

4. Governing Law. This Agreement shall be governed by the laws of Delaware.

5. General Provisions. This Agreement may be executed in any number of counterparts, each of which shall be deemed to be an original, and all of which together shall constitute one and the same instrument. Delivery of an executed counterpart of a signature page to this Agreement by facsimile or electronic mail shall be as effective as delivery of a manually executed counterpart of this Agreement. This Agreement may not be supplemented, altered, or modified in any manner except by a writing signed by all parties hereto. The failure of any party to enforce any terms or provisions of this Agreement shall not waive any of its rights under such terms or provisions. In the event of a conflict between the terms and conditions of this Agreement and the terms and conditions of the Master Sale Agreement or any of the Ancillary Agreements (as defined in the Master Sale Agreement), the terms and conditions of the Master Agreement (or the applicable Ancillary Agreement) shall govern.

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PATENT ASSIGNMENT AGREEMENT

IN WITNESS WHEREOF, Assignor and Assignee have caused this instrument to be executed by their respective duly authorized representative as of the Effective Date.

Assignor:

CLUSTER LLC

By: AB Aulis, *its manager*

By 
Name: Nina Macpherson
Title: Senior Vice President and General
Counsel

By 
Name: Richard Fleetwood
Title: V.P.

Assignee:

UNWIRED PLANET LLC

By _____
Name: Eric J. Vetter
Title: President and CFO/CEO

PATENT ASSIGNMENT AGREEMENT

IN WITNESS WHEREOF, Assignor and Assignee have caused this instrument to be executed by their respective duly authorized representative as of the Effective Date.

Assignor:

CLUSTER LLC

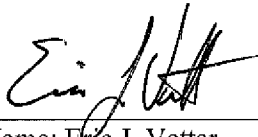
By: AB Aulis, *its manager*

By _____
Name:
Title:

By _____
Name:
Title:

Assignee:

UNWIRED PLANET LLC

By  _____
Name: Eric J. Vetter
Title: President and CFO/CEO

Ericsson Ref	EIP Ref	Country	Status	App Number	Filing Date	Patent Number	Patent Date
P24349 AE1	E5133.001(T).AE	AE	FILED	1177/2009	2008-04-03		
P24890 AT1	E5142.500(T).AT(EP W)	AT	GRANTED	08844758.6	2008-10-27	AT 524046 T (EP 2206395 B1)	2011-09-07
P09311 AU1	E6256.001(T).AUW	AU	GRANTED	33303/99	1999-03-11	AU 760201 B2	2003-08-21
P11966 AU1	E6437.001(T).AUW	AU	GRANTED	13205-01	2000-10-26	AU 770576 B2	2004-06-10
P24890 BE1	E5142.500(T).BE(EP W)	BE	GRANTED	08844758.6	2008-10-27	EP 2206395 B1	2011-09-07
P24349 BR1	E5133.001(T).BR	BR	FILED	PI 0813769-2	2008-04-03		
P24349 CA1	E5133.001(T).CAW	CA	FILED	2692109	2008-04-03		
P24890 CA1	E5142.500(T).CAW	CA	FILED	2704189	2008-10-27		
P11966 CA1	E6437.001(T).CAW	CA	GRANTED	2386929	2000-10-26	CA 2386929 C	2011-10-18
P24890 CH1	E5142.500(T).CH(EP W)	CH	GRANTED	08844758.6	2008-10-27	EP 2206395 B1	2011-09-07
P10831 CN1	E5026.450(T).CNW	CN	GRANTED	99811094-9	1999-09-14	CN 1133284 C	2003-12-31
P20271 CN1	E5096.750(T).CNW#	CN	GRANTED	200580049806-9	2005-05-16	CN 101180828 B	2012-12-05
P24349 CN1	E5133.001(T).CNW	CN	FILED	200880021636.7	2008-04-03		
P24890 CN1	E5142.500(T).CNW	CN	FILED	200880113771.4	2008-10-27		
P31232 CN1	E5168(T).CNW	CN	FILED	201080064250.1	2010-06-28		
P07648 CN1	E6161.001(T).CNW	CN	GRANTED	98801940-X	1998-01-13	CN 1115789 C	2003-07-23
P08855 CN1	E6224.850(T).CNW	CN	GRANTED	98810788-0	1998-11-10	CN 1146101 C	2004-04-14
P09311 CN1	E6256.001(T).CNW	CN	GRANTED	99803882-2	1999-03-11	CN 1116734 C	2003-07-30
P11966 CN1	E6437.001(T).CNW	CN	GRANTED	00815022-2	2000-10-26	CN 1160849 C	2004-08-04
P24890 CO1	E5142.500(T).CO	CO	FILED	10-041183	2008-10-27		
P24890 CZ1	E5142.500(T).CZ(EP W)	CZ	GRANTED	08844758.6	2008-10-27	EP 2206395 B1	2011-09-07
P10831 DE1	E5026.450(T).DE(EP W)	DE	GRANTED	99951323-7	1999-09-14	DE 69910046 D1 (EP 1114527 B1)	2003-07-30
P24890 DE1	E5142.500(T).DE(EP W)	DE	GRANTED	08844758.6	2008-10-27	DE 602008009658 D1 (EP 2206395 B1)	2011-09-07
P07648 DE1	E6161.001(T).DE(EP W)	DE	GRANTED	98901614-2	1998-01-13	DE 69833184 D1 (EP 0963626 B1)	2006-01-11
P07812 DE1	E6169.450(T).DE#	DE	GRANTED	19706985-1	1997-02-21	DE 19706985 B4	2003-02-22
P09058 DE1	E6245.250(T).DE#	DE	GRANTED	P19803796-1	1998-01-30	DE 19803796 B4	2006-10-26
P09311 DE1	E6256.001(T).DE(EP W)	DE	GRANTED	99914512.1	1999-03-11	DE 69942363 D1 (EP 1062725 B1)	2010-05-12
P09152 DE1	E6268.400(T).DE#	DE	GRANTED	P19820248-2	1998-05-06	DE 19820248 B4	2006-02-23

Ericsson Ref	EIP Ref	Country	Status	App Number	Filing Date	Patent Number	Patent Date
P11966 DE1	E6437.001(T).DE(EP W)	DE	GRANTED	600 39 906.0	2000-10-26	DE 60039906 D1 (EP 1234376 B1)	2008-08-13
P12398 DE1	E6466.650(T).DE(EP #)	DE	GRANTED	00101675-7	2000-02-02	DE 60024404 D1 (EP 1122921 B1)	2005-11-30
P14423 DE1	E6575.700(T).DE(EP W)	DE	GRANTED	60222673.2-08	2002-06-28	DE 60222673 D1 (EP 1417759 B1)	2007-09-26
P10831 EP1	E5026.450(T).EPW	EP	GRANTED	99951323.7	1999-09-14	EP 1114527 B1	2003-07-30
P20271 EP1	E5096.750(T).EPW#	EP	FILED	05747900.8	2005-05-16		
P22325 EP1	E5117.950(T).EPW#	EP	FILED	06769586.6	2006-07-26		
P24349 EP1	E5133.001(T).EPW	EP	FILED	08724329.1	2008-04-03		
P24890 EP1	E5142.500(T).EPW	EP	GRANTED	08844758.6	2008-10-27	EP 2206395 B1	2011-09-07
P31232 EP1	E5168(T).EPW	EP	FILED	10774303.1	2010-06-28		
P07648 EP1	E6161.001(T).EPW	EP	GRANTED	98901614.2	1998-01-13	EP 0963626 B1	2006-01-11
P07812 EP1	E6169.450(T).EPW	EP	GRANTED	98912338.5	1998-02-19	EP 0960476 B1	2002-06-05
P08855 EP1	E6224.850(T).EPW	EP	GRANTED	98958422.2	1998-11-10	EP 1032970 B1	2003-04-02
P09311 EP1	E6256.001(T).EPW	EP	GRANTED	99914512.1	1999-03-11	EP 1062725 B1	2010-05-12
P11966 EP1	E6437.001(T).EPW	EP	GRANTED	00975108.2	2000-10-26	EP 1234376 B1	2008-08-13
P12398 EP1	E6466.650(T).EP#	EP	GRANTED	00101675.7	2000-02-02	EP 1122921 B1	2005-11-30
P14423 EP1	E6575.700(T).EPW	EP	GRANTED	02754791.8	2002-06-28	EP 1417759 B1	2007-09-26
P24890 ES1	E5142.500(T).ES(EP W)	ES	GRANTED	08844758.6	2008-10-27	EP 2206395 B1	2011-09-07
P11966 ES1	E6437.001(T).ES(EP W)	ES	GRANTED	00975108-2	2000-10-26	ES 2311477 T3 (EP 1234376 B1)	2008-08-13
P24890 FR1	E5142.500(T).FR(EP W)	FR	GRANTED	08844758.6	2008-10-27	EP 2206395 B1	2011-09-07
P12398 FR1	E6466.650(T).FR(EP #)	FR	GRANTED	00101675-7	2000-02-02	EP 1122921 B1	2005-11-30
P24890 GB1	E5142.500(T).GB(EP W)	GB	GRANTED	08844758.6	2008-10-27	EP 2206395 B1	2011-09-07
P07812 GB1	E6169.450(T).GB(EP W)	GB	GRANTED	98912338-5	1998-02-19	EP 0960476 B1	2002-06-05
P08855 GB1	E6224.850(T).GB(EP W)	GB	GRANTED	98958422-2	1998-11-10	EP 1032970 B1	2003-04-02
P09311 GB1	E6256.001(T).GB#	GB	GRANTED	9805456-2	1998-03-13	GB 2335322 B	2002-04-24
P09306 GB1	E6258.500(T).GB#	GB	GRANTED	9806205-2	1998-03-24	GB 2335809 B	2001-09-12
P11966 GB1	E6437.001(T).GB(EP W)	GB	GRANTED	00975108-2	2000-10-26	EP 1234376 B1	2008-08-13
P12398 GB1	E6466.650(T).GB(EP #)	GB	GRANTED	00101675-7	2000-02-02	EP 1122921 B1	2005-11-30
P14423 GB1	E6575.700(T).GB(EP W)	GB	GRANTED	02754791-8	2002-06-28	EP 1417759 B1	2007-09-26

Ericsson Ref	EIP Ref	Country	Status	App Number	Filing Date	Patent Number	Patent Date
P10831 HK1	E5026.450(T).HK(CN W)	HK	FILED	02102936-1	1999-09-14		
P24890 HK1	E5142.500(T).HK(CN W)	HK	FILED	11102684.4	2008-10-27		
P31232 HK1	E5168(T).HK(CNW)	HK	FILED	13104805.2	2010-06-28		
P31232 ID1	E5168(T).ID	ID	FILED	W-00 2012 03245	2010-06-28		
P08855 ID1	E6224.850(T).ID	ID	GRANTED	W2000/1145	1998-11-10	ID 12622	2004-02-11
P10831 IL1	E5026.450(T).ILW	IL	GRANTED	141478	1999-09-14	IL 141478	2006-03-19
P22325 IN1	E5117.950(T).INW	IN	FILED	113/DELNP/2009	2006-07-26		
P24349 IN1	E5133.001(T).INW	IN	FILED	2365/MUMNP/2009	2008-04-03		
P24890 IN1	E5142.500(T).INW	IN	FILED	1633/CHENP/2010	2008-10-27		
P31232 IN1	E5168(T).INW	IN	FILED	2606/KOLNP/2012	2010-06-28		
P24890 IT1	E5142.500(T).IT(EP W)	IT	GRANTED	08844758.6	2008-10-27	EP 2206395 B1	2011-09-07
P10831 JP1	E5026.450(T).JPWD 1	JP	GRANTED	2010-207055	2010-09-15	JP 4705195 B2	2011-03-18
P24349 JP1	E5133.001(T).JPW	JP	GRANTED	2010-514689	2008-04-03	JP 4914935 B2	2012-01-27
P24349 JP2	E5133.001(T).JPWD 1	JP	FILED	2012-010258	2012-01-20		
P24890 JP1	E5142.500(T).JPW	JP	FILED	02010-530963	2008-10-27		
P07812 JP1	E6169.450(T).JPW	JP	GRANTED	10-536251	1998-02-19	JP 3967386 B2	2007-06-08
P08855 JP1	E6224.850(T).JPW	JP	GRANTED	2000-521585	1998-11-10	JP 4008657 B2	2007-09-07
P09058 JP1	E6245.250(T).JPW	JP	GRANTED	2000-529791	1999-01-25	JP 4237402 B2	2008-12-26
P09306 JP1	E6258.500(T).JPW	JP	GRANTED	2000-538428	1999-03-19	JP 4329975 B2	2009-06-26
P11966 JP1	E6437.001(T).JPW	JP	GRANTED	2001-533621	2000-10-26	JP 4050054 B2	2007-12-07
P12398 JP1	E6466.650(T).JP	JP	GRANTED	201-027573	2001-02-02	JP 4671381 B2	2011-01-28
P10831 KR1	E5026.450(T).KRW	KR	GRANTED	10-2001-7003486	1999-09-14	KR 100663829 B1	2006-12-26
P10831 MY1	E5026.450(T).MY	MY	GRANTED	PI9903908	1999-09-09	MY 118575	2004-12-31
P24890 NL1	E5142.500(T).NL(EP W)	NL	GRANTED	08844758.6	2008-10-27	EP 2206395 B1	2011-09-07
P09311 NL1	E6256.001(T).NL(EP W)	NL	GRANTED	99914512.1	1999-03-11	EP 1062725 B1	2010-05-12
P24890 NZ1	E5142.500(T).NZW	NZ	GRANTED	584097	2008-10-27	NZ 584097	2013-01-04
P24349 PH1	E5133.001(T).PHW	PH	FILED	1-2009-502426	2008-04-03		
P24890 PL1	E5142.500(T).PL(EP W)	PL	GRANTED	08844758.6	2008-10-27	EP 2206395 B1	2011-09-07

Ericsson Ref	EIP Ref	Country	Status	App Number	Filing Date	Patent Number	Patent Date
P24890 PT1	E5142.500(T).PT(EP W)	PT	GRANTED	08844758.6	2008-10-27	EP 2206395 B1	2011-09-07
P24890 RU1	E5142.500(T).RUW	RU	FILED	2010121841	2008-10-27		
P31232 RU1	E5168(T).RUW	RU	FILED	2012139962 (PCT/SE2010/05 0735)	2010-06-28		
P08855 RU1	E6224.850(T).RUW	RU	GRANTED	2000115567	1998-11-10	RU 2204194 C2	2003-05-10
P24349 SE1	E5133.001(T).SE#	SE	FILED	0701582-9	2007-06-27		
P07648 SE1	E6161.001(T).SE#	SE	GRANTED	9700169-7	1997-01-21	SE 508290 C2	1998-09-21
P11966 SE1	E6437.001(T).SE#	SE	GRANTED	9903917/4	1999-10-29	SE 519596 C2	2003-03-18
P24349 SG1	E5133.001(T).SGW	SG	GRANTED	200908333-8	2008-04-03	SG 157719	2012-09-14
P24890 TR1	E5142.500(T).TR(EP W)	TR	GRANTED	08844758.6	2008-10-27	EP 2206395 B1	2011-09-07
P07812 TW1	E6169.450(T).TW	TW	GRANTED	87101862	1998-02-10	NI107527 (TW 370753 B)	2000-01-31
P09058 TW1	E6245.250(T).TW	TW	GRANTED	88100898	1999-01-21	NI131444 (TW 432842 B)	2001-02-09
P09152 TW1	E6268.400(T).TW	TW	GRANTED	88107299	1999-05-05	NI169770 (TW 517456 B)	2003-05-07
P12398 TW1	E6466.650(T).TW	TW	GRANTED	89127991	2000-12-27	NI184031 (TW 548926 B)	2003-12-18
P14422 TW1	E6567.001(T).TW	TW	GRANTED	091108837	2002-04-29	NI190999 (TW 564591 B)	2004-03-17
P10831 US1	E5026.450(T).US#	US	GRANTED	09/156695	1998-09-18	US 6519236 B1	2003-02-11
P20271 US1	E5096.750(T).USW#	US	GRANTED	11/914292	2005-05-16	US 7961875 B2	2011-06-14
P22325 US1	E5117.950(T).USW#	US	GRANTED	12/375116	2006-07-26	US 8400927 B2	2013-03-19
P24349 US1	E5133.001(T).USW	US	FILED	12/666115	2008-04-03		
P24890 US1	E5142.500(T).USW	US	FILED	12/740053	2008-10-27		
P24890 US2	E5142.500(T).USWC 1	US	FILED	14/072004	2013-11-05		
P31232 US1	E5168(T).USW	US	FILED	13/577791	2010-06-28		
P07648 US1	E6161.001(T).US	US	GRANTED	09/006867	1998-01-14	US 6091963 A	2000-07-18
P07812 US1	E6169.450(T).USW	US	GRANTED	09/367637	1998-02-19	US 6215339 B1	2001-04-10
P08219 US1	E6193.800(T).US	US	GRANTED	09/113241	1998-07-10	US 6184814 B1	2001-02-06
P08572 US1	E6209.350(T).US#	US	GRANTED	08/931302	1997-09-16	US 6011815 A	2000-01-04
P08664 US1	E6222.850(T).US#	US	GRANTED	08/964645	1997-11-05	US 6025995 A	2000-02-15
P08855 US1	E6224.850(T).US#	US	GRANTED	08/971770	1997-11-17	US 5880643 A	1999-03-09
P09058 US1	E6245.250(T).USW	US	GRANTED	09/628185	1999-01-25	US 6307402 B1	2001-10-23

Ericsson Ref	EIP Ref	Country	Status	App Number	Filing Date	Patent Number	Patent Date
P09311 US1	E6256.001(T).US	US	GRANTED	09/266844	1999-03-12	US 6198355 B1	2001-03-06
P09306 US1	E6258.500(T).US	US	GRANTED	09/274331	1999-03-23	US 6104238 A	2000-08-15
P09307 US1	E6258.501(T).US	US	GRANTED	09/274330	1999-03-23	US 6259315 B1	2001-07-10
P09308 US1	E6258.502(T).US	US	GRANTED	09/274479	1999-03-23	US 6188275 B1	2001-02-13
P09152 US1	E6268.400(T).US	US	GRANTED	09/304047	1999-05-04	US 6166570 A	2000-12-26
P10196 US1	E6360.001(T).US	US	GRANTED	09/468365	1999-12-21	US 6636605 B1	2003-10-21
P11966 US1	E6437.001(T).US	US	GRANTED	09/697475	2000-10-27	US 6727750 B1	2004-04-27
P12398 US1	E6466.650(T).US	US	GRANTED	09/770406	2001-01-29	US 6665351 B2	2003-12-16
P14422 US1	E6567.001(T).US	US	GRANTED	10/143668	2002-05-08	US 6696890 B2	2004-02-24
P14423 US1	E6575.700(T).USW	US	GRANTED	10/482811	2002-06-28	US 7321239 B2	2008-02-22
P12949 US1	E6580.950(T).US	US	GRANTED	10/234180	2002-09-05	US 6724247 B2	2004-04-20
P31232 ZA1	E5168(T).ZAW	ZA	FILED	2012/04966	2010-06-28		2013-09-25